# Preliminary



RFM products are now Murata products.

#### Precision IF SAW Filter

- Hermetic 13.3 x 6.5 mm Surface-mount Case
- Complies with Directive 2002/95/EC (RoHS)

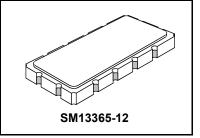


#### **Absolute Maximum Ratings**

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Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Maximum DC Voltage between any Two Terminals	3	VDC	
Storage Temperature Range in Tape and Reel	-40 to +85 °C		
Suitable for Lead-free Soldering - Maximum Soldering Profile	ering Profile 260°C for 30 s		

# SF2189A

## 140 MHz **SAW Filter**



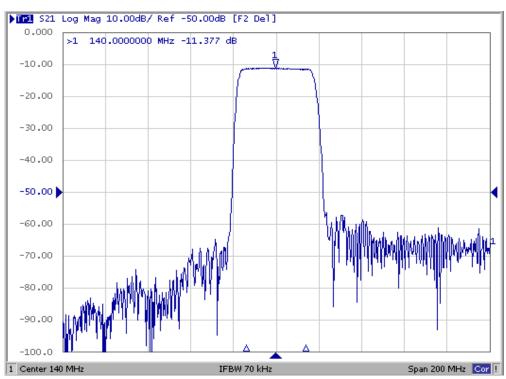
#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	F <sub>C</sub>	1		140		MHz
Minimum Insertion Loss	IL <sub>MIN</sub>	1		11.3	13.0	dB
1 dB Bandwidth	BW <sub>1</sub>	1	30.0	33.0		MHz
3 dB Bandwidth	BW <sub>3</sub>	1	32.0	35.0		MHz
35 dB Bandwidth	BW <sub>35</sub>	1		42.4	44.0	MHz
Passband Amplitude Ripple, 80% of 3 dB Bandwidth		1, 2, 3		0.6	1.2	dB <sub>P-P</sub>
Passband Group Delay Ripple, 80% of 3 dB Bandwidth		1, 2, 3		50	120	ns <sub>P-P</sub>
Passband Absolute Group Delay		1,2,3		0.55		μs
Passband Phase Linearity, 80% of 3 dB Bandwidth		1, 2, 3		5	14	deg <sub>P-P</sub>
Operating Temperature		1	-20		+80	°C
Frequency Temperature Coefficient				-94		ppm/°C
Source Impedance				50		ohm
Load Impedance				50		ohm
		•		•	•	•
Case Style		SM13365-12 13.3 x 6.5 mm Nominal Footprint				
Lid Symbolization (YY = year, WW = week)		RFM SF2189A YYWW				

	CAUTION: Electrostatic Sensitive Device. Observe precautions for handling
ノ	Notes:

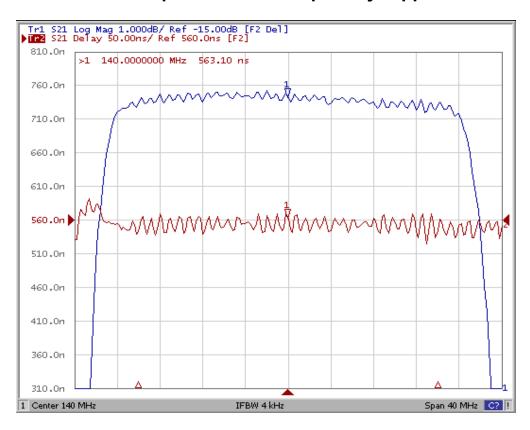
- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- 2. 3.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details. Part to part absolute delay measurement records the absolute delay mean across 1 dB passband. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 4. 5.

  - The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply. 6. 7.
  - 8.

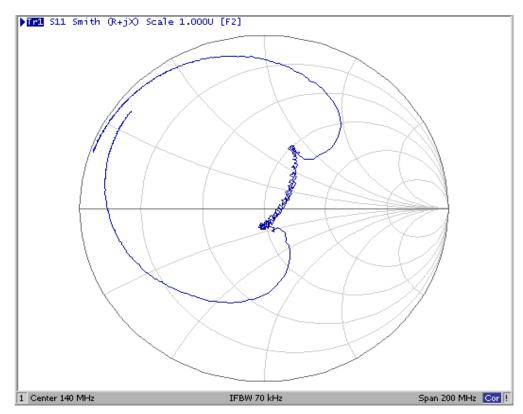


### SF2189A Filter Response

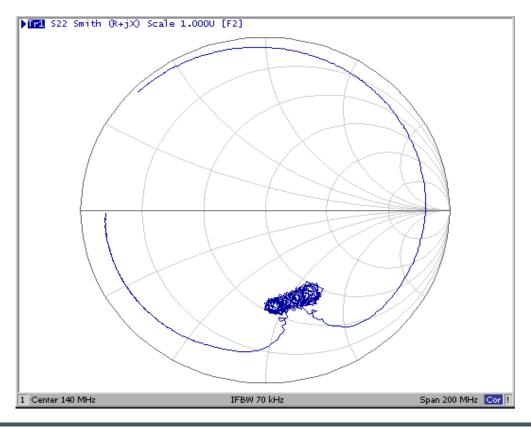
#### SF2189A Passband Amplitude and Group Delay Ripple



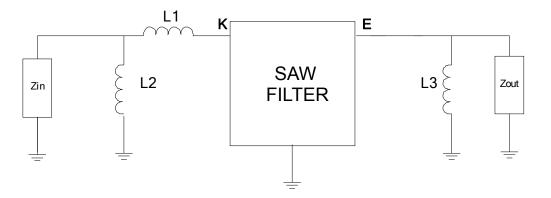
### SF2189A Input Impedance (K Port)



## SF2189A Output Impedance (E Port)

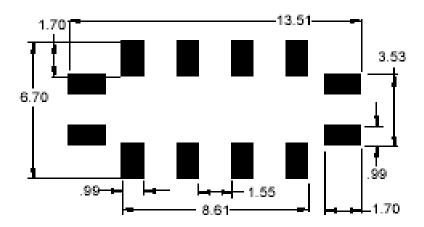


SF2189A 50 ohm Matching Network



L1 = 10 nH, L2 = 27 nH, L3 = 68 nH

SF2189A PCB Pad Layout

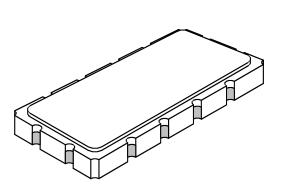


# SM13365-12 Case

## **12-Terminal Ceramic Surface-Mount Case**

### 13.3 x 6.5 mm Nominal Footprint

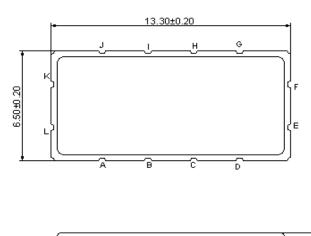
#### Case Dimensions

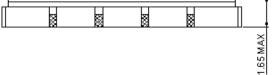


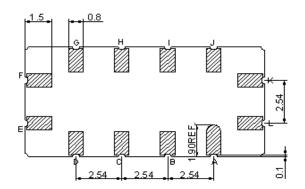
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	13.08	13.31	13.60	0.515	0.524	0.535
В	6.27	6.50	6.80	0.247	0.256	0.268
С		1.91	2.00		0.075	0.079
D		1.50			0.059	
E		0.79			0.031	
Н		1.0			0.039	
Р		2.54			0.100	
Electrical Connections						
Connection	Connection					

Connection	Terminals
Input	К
Output	E
Case Ground	All others

Materials					
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel				
Lid Plating	2.0 to 3.0 µm Nickel				
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic				
Pb Free	•				







## **Tape and Reel Details**

